

February 2008

MM74HC164 8-Bit Serial-in/Parallel-out Shift Register

Features

- Typical operating frequency: 50MHz
- Typical propagation delay: 19ns (clock to Q)
- Wide operating supply voltage range: 2V to 6V
- Low input current: 1µA maximum
- Low quiescent supply current: 80µA maximum (74HC Series)
- Fanout of 10 LS-TTL loads

General Description

The MM74HC164 utilizes advanced silicon-gate CMOS technology. It has the high noise immunity and low consumption of standard CMOS integrated circuits. It also offers speeds comparable to low power Schottky devices.

This 8-bit shift register has gated serial inputs and CLEAR. Each register bit is a D-type master/slave flipflop. Inputs A & B permit complete control over the incoming data. A LOW at either or both inputs inhibits entry of new data and resets the first flip-flop to the low level at the next clock pulse. A high level on one input enables the other input which will then determine the state of the first flip-flop. Data at the serial inputs may be changed while the clock is HIGH or LOW, but only information meeting the setup and hold time requirements will be entered. Data is serially shifted in and out of the 8-bit register during the positive going transition of the clock pulse. Clear is independent of the clock and accomplished by a low level at the CLEAR input.

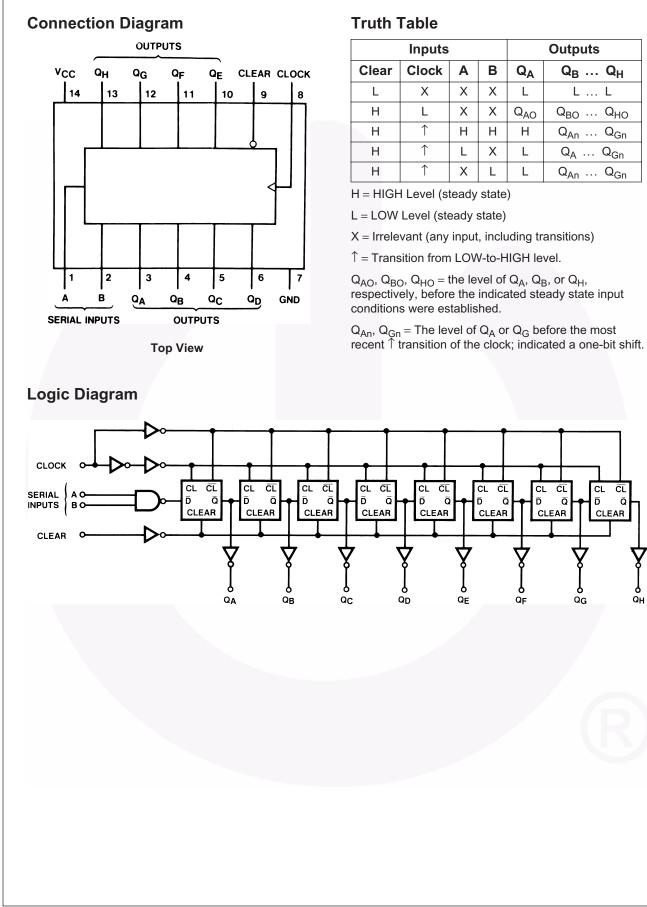
The 74HC logic family is functionally as well as pin-out compatible with the standard 74LS logic family. All inputs are protected from damage due to static discharge by internal diode clamps to V_{CC} and ground.

Ordering Information

Order Number	Package Number	Package Description
MM74HC164M	M14A	14-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-012, 0.150" Narrow
MM74HC164MTC	MTC14	14-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 4.4mm Wide
MM74HC164N	N14A	14-Lead Plastic Dual-In-Line Package (PDIP), JEDEC MS-001, 0.300" Wide

Device also available in Tape and Reel. Specify by appending suffix letter "X" to the ordering number.

All packages are lead free per JEDEC: J-STD-020B standard.



CL

ā

QH

Absolute Maximum Ratings⁽¹⁾

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only.

Symbol	Parameter	Rating
V _{CC}	Supply Voltage	-0.5 to +7.0V
V _{IN}	DC Input Voltage	–1.5 to V _{CC} +1.5V
V _{OUT}	DC Output Voltage	–0.5 to V _{CC} +0.5V
I _{IK} , I _{OK}	Clamp Diode Current	±20mA
I _{OUT}	DC Output Current, per pin	±25mA
I _{CC}	DC V _{CC} or GND Current, per pin	±50mA
T _{STG}	Storage Temperature Range	–65°C to +150°C
P _D	Power Dissipation Note 2	600mW
	S.O. Package only	500mW
TL	Lead Temperature (Soldering 10 seconds)	260°C

Notes:

1. Unless otherwise specified all voltages are referenced to ground.

2. Power Dissipation temperature derating - plastic "N" package: -12mW/°C from 65°C to 85°C.

Recommended Operating Conditions

The Recommended Operating Conditions table defines the conditions for actual device operation. Recommended operating conditions are specified to ensure optimal performance to the datasheet specifications. Fairchild does not recommend exceeding them or designing to absolute maximum ratings.

Symbol	Parameter	Min.	Max.	Units
V _{CC}	Supply Voltage	2	6	V
V _{IN} , V _{OUT}	DC Input or Output Voltage	0	V _{CC}	V
T _A	Operating Temperature Range		+85	°C
t _r , t _f	Input Rise or Fall Times $V_{CC} = 2.0V$		1000	ns
	$V_{CC} = 4.5V$		500	ns
	$V_{CC} = 6.0 V$		400	ns

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DC Electrical Characteristics⁽³⁾

				T _A =	25°C	T _A =-40°C to 85°C	T _A = -55°C to 125°C	
Symbol	Parameter	V _{CC} (V)	Conditions	Тур.		Guaranteed	Units	
V _{IH}	Minimum HIGH Level	2.0			1.5	1.5	1.5	V
	Input Voltage	4.5			3.15	3.15	3.15	
		6.0			4.2	4.2	4.2	
V _{IL}	Maximum LOW Level	2.0			0.5	0.5	0.5	V
	Input Voltage	4.5			1.35	1.35	1.35	
		6.0			1.8	1.8	1.8	
V _{OH}	Minimum HIGH Level	2.0	$V_{IN} = V_{IH} \text{ or } V_{IL},$	2.0	1.9	1.9	1.9	V
Output Voltage	Output Voltage	4.5	I _{OUT} ≤ 20μΑ	4.5	4.4	4.4	4.4	1
		6.0		6.0	5.9	5.9	5.9	
		4.5	$V_{IN} = V_{IH} \text{ or } V_{IL},$ $ I_{OUT} \le 4.0 \text{mA}$	4.2	3.98	3.84	3.7	
		6.0	$V_{IN} = V_{IH} \text{ or } V_{IL},$ $ I_{OUT} \le 5.2 \text{mA}$	5.7	5.48	5.34	5.2	
V _{OL} Maxim	Maximum LOW Level	2.0	$V_{IN} = V_{IH} \text{ or } V_{IL},$	0	0.1	0.1	0.1	V
	Output Voltage	4.5	I _{OUT} ≤ 20μΑ	0	0.1	0.1	0.1	1
		6.0		0	0.1	0.1	0.1	
		4.5	$V_{IN} = V_{IH} \text{ or } V_{IL},$ $ I_{OUT} \le 4.0 \text{mA}$	0.2	0.26	0.33	0.4	
		6.0	$V_{IN} = V_{IH} \text{ or } V_{IL},$ $ I_{OUT} \le 5.2 \text{mA}$	0.2	0.26	0.33	0.4	
I _{IN}	Maximum Input Current	6.0	$V_{IN} = V_{CC}$ or GND		±0.1	±1.0	±1.0	μΑ
I _{CC}	Maximum Quiescent Supply Current	6.0	$V_{IN} = V_{CC}$ or GND, $I_{OUT} = 0\mu A$		8.0	80	160	μA

Note:

3. For a power supply of 5V ±10% the worst case output voltages (V_{OH}, and V_{OL}) occur for HC at 4.5V. Thus the 4.5V values should be used when designing with this supply. Worst case V_{IH} and V_{IL} occur at V_{CC} = 5.5V and 4.5V respectively. (The V_{IH} value at 5.5V is 3.85V.) The worst case leakage current (I_{IN}, I_{CC}, and I_{OZ}) occur for CMOS at the higher voltage and so the 6.0V values should be used.

AC Electrical Characteristics

 $V_{CC} = 5V, T_A = 25^{\circ}C, C_L = 15pF, t_r = t_f = 6ns$

Symbol	Parameter	Conditions	Тур.	Guaranteed Limit	Units
f _{MAX}	Maximum Operating Frequency			30	MHz
t _{PHL} , t _{PLH}	Maximum Propagation Delay, Clock to Output		19	30	ns
t _{PHL}	Maximum Propagation Delay, Clear to Output		23	35	ns
t _{REM}	Minimum Removal Time, Clear to Clock		-2	0	ns
t _S	Minimum Setup Time, Data to Clock		12	20	ns
t _H	Minimum Hold Time, Clock to Data		1	5	ns
t _W	Minimum Pulse Width, Clear or Clock		10	16	ns

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AC Electrical Characteristics

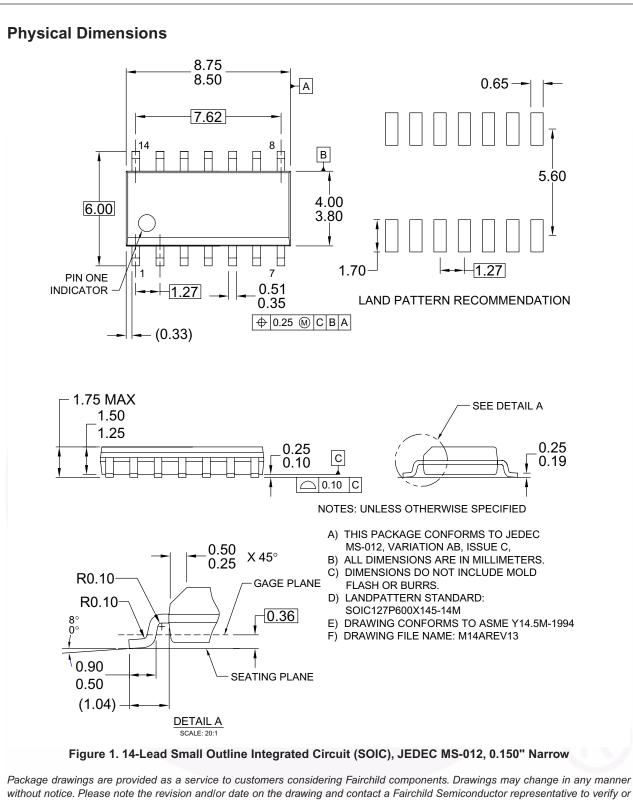
 $C_L = 50 pF$, $t_r = t_f = 6ns$ (unless otherwise specified)

				T _A =	25°C	T _A =-40°C to 85°C	T _A = -55°C to 125°C	
Symbol	Parameter	V _{CC} (V)	Conditions	Тур.		Guaranteed	Limits	Units
f _{MAX}	Maximum Operating	2.0			5	4	3	MHz
	Frequency	4.5			27	21	18]
		6.0			31	24	20]
t _{PHL} , t _{PLH}	Maximum Propagation	2.0		115	175	218	254	ns
	Delay, Clock to Output	4.5		13	35	44	51	
		6.0		20	30	38	44	
t _{PHL}	Maximum Propagation	2.0		140	205	256	297	ns
	Delay, Clear to Output	4.5		28	41	51	59]
		6.0		24	35	44	51]
t _{REM}	Minimum Removal	2.0		-7	0	0	0	ns
	Time, Clear to Clock	4.5		-3	0	0	0]
		6.0		-2	0	0	0	1
t _S	Minimum Setup Time,	2.0		25	100	125	150	ns
	Data to Clock	4.5		14	20	25	30	
		6.0		12	17	21	25	
t _H	Minimum Hold Time,	2.0		-2	5	5	5	ns
	Clock to Data	4.5		0	5	5	5	1
		6.0		1	5	5	5	1
t _W	Minimum Pulse Width	2.0		22	80	100	120	ns
	Clear or Clock	4.5		11	16	20	24	1
		6.0		10	14	18	20	1
t _{THL} , t _{TLH}	Maximum Output	2.0			75	95	110	ns
	Rise and Fall Time	4.5			15	19	22	1
		6.0			13	16	19	1
	Maximum Input	2.0			1000	1000	1000	ns
	Rise and Fall Time	4.5			500	500	500	1
		6.0			400	400	400	1
C _{PD}	Power Dissipation Capacitance ⁽⁴⁾	5.0	(per package)	150				pF
C _{IN}	Maximum Input Capacitance			5	10	10	10	pF

Note:

4. C_{PD} determines the no load dynamic power consumption, $P_D = C_{PD} V_{CC}^2 f + I_{CC} V_{CC}$, and the no load dynamic current consumption, $I_S = C_{PD} V_{CC} f + I_{CC}$.

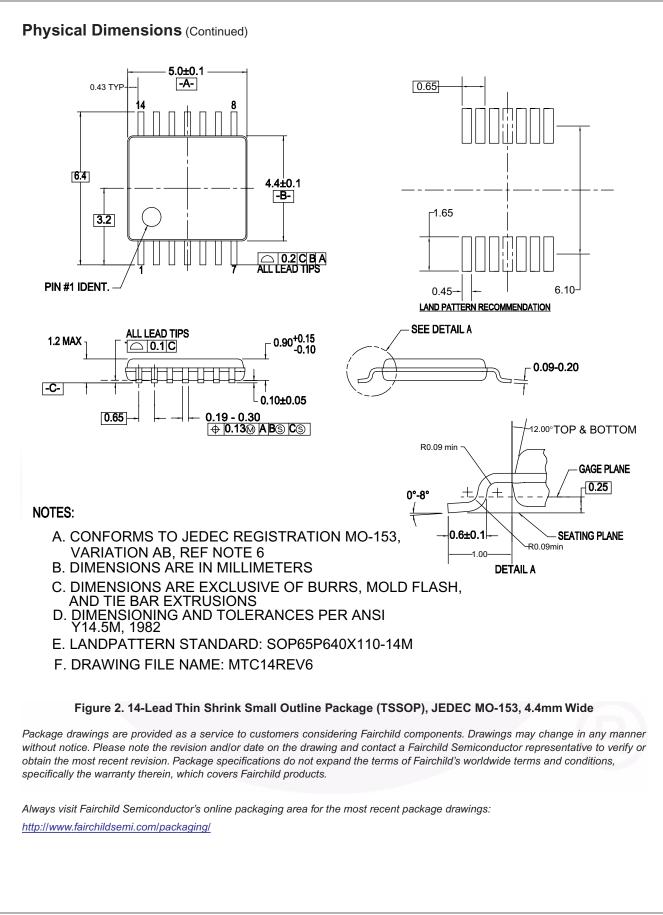


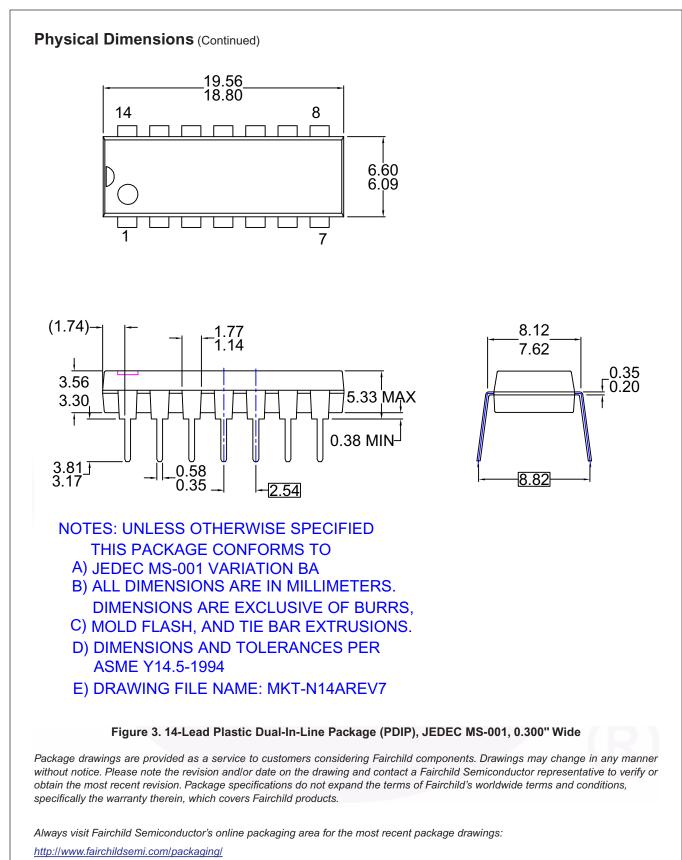


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